

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Basceri et al.

Application No. 09/965,509 Filed: September 26, 2001 Confirmation No. 3307

For: METHODS FOR FORMING AND

> INTEGRATED CIRCUIT STRUCTURES CONTAINING ENHANCED-SURFACE-

AREA CONDUCTIVE LAYERS

Examiner: Toniae M. Thomas

Art Unit: 2822

Attorney Reference No. 6047-59403

COMMISSIONER FOR PATENTS P.O. BOX 1450 **ALEXANDRIA, VA 22313-1450**

CERTIFICATE OF MAILING

I hereby certify that this paper and the documents referred to as being attached or enclosed herewith are being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: COMMISSIONER FOR PATENTS, P.O. BOX 1450, ALEXANDRIA, VA 22313-1450 on the date shown below.

Attorney for Applicant(s)

Date Mailed November 12, 2003

RESPONSE

This responds to the Office action dated May 28, 2003. Please amend the referenced application as follows:

Amendments to the Claims are reflected in the listing of claims, which begins on page?

Remarks begin on page 6.

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